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1	CMC Conference April 26-27, 2018 - Phoenix			
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3			Presenter	Presentation Subject/Title
4		8:00	Ed Korczynski, CMCC Co-Chair	OPENING REMARKS
5	KEYNOTE	8:15	KEYNOTE: David Bloss (VP/Director) Intel	Patterning Challenges and Fab Materials for Future ICs
6	1. Global Issues	9:00	Scott Jones (Managing Director) KPMG	Macroeconomics
7		9:30	Jim Feldham (Partner) Semico	IC Device Trends
8		10:00	COFFEE BREAK	
9		10:15	Lita Shon-Roy (President) TECHCET	Critical Materials market forecast & roadmap
10		10:45	Keith Long (Director) USGS	Global Tantalum supply-chain: trends and future challenges
11		11:15	James Votaw (Partner) Keller & Heckman	Regulatory Challenges for Novel Engineered Materials
12		11:45	Jeff Morris (Director) US EPA	TSCA Implementation Update
13		12:15	LUNCH	
14				
15	2. Materials Issues Today	1:30 PM	Mark Scholefield (Sr. MTS) GLOBALFOUNDRIES	Silicon Wafer quality roadmaps
16		2:00 PM	Ken Unfried (Manager) Linde	Neon and Xenon recycling
17		2:30 PM	Terry Francis (Sr. Analyst) TECHCET	ALD / CVD / PVD Metal materials markets
18		3:00 PM	COFFEE BREAK	
19		3:15 PM	Reg Parker (Business Lead) NXP	Reverse supply-chain logistics and IP control
20		3:45 PM	Michelle Garza (Sr. R&D Chemist) Fujimi	Quick turnaround slurry ramp process...????
21		4:15 PM	Dennis Brestovansky (Director) Praxair	Ion Implant critical materials
22		4:45 PM	Risto Puhakka (President) VLSI Research	OEM Markets and Materials Trends
23		5:15-6:30 PM	ROUNDTABLES	Break-out Topic Discussions over Craft Beer and Soda
24				
25	3. Near Future Materials	8:00	Sanjeev Aggarwal (VP R&D) Everspin	Magnetic Materials for Manufacturing ICs
26		8:30	Glen Wilk (VP ALD Products) ASM	ALD (High-K limits, or SAQP, or ???)
27		9:00	Nicolas Blasco (Director) Air Liquide	Ru precursors, & Co precursors issues
28		9:30	Lukas Gerlich (technologist) Fraunhofer	Cobalt integration solutions - integration (R&D accelerator)
29		10:00	COFFEE BREAK	
30		10:15	Ed Korczynski (Sr. Analyst) TECHCET	Multi-patterning cost modeling
31		10:45	Alok Ranjan (Director) TEL	Quasi ALE SiN technology
32		11:15	David Thompson (Sr. Director) Applied Materials	Ruthenium Integration
33		11:45	Jonas Sundquist, CMCC Co-Chair	CONCLUDING REMARKS